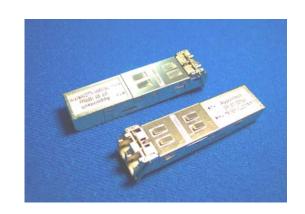


Features

- Compliant with SFP MSA and SFF-8472(Rev 9.3)
- Compliant with IEEE 802.3z Gigabit Ethernet 1000BASE-LX specification
- SFF-8472 Digital Diagnostic Monitoring Interface with real time monitors
 - Transmitter Output Power
 - Receiver Input Power
 - Laser Bias Current
 - Temperature
 - Supply Voltage
- Internal calibration for Digital Diagnostic Monitoring
- Alarms and warnings to indicate status of real time monitors
- Metal case & LC receptacle with bail de-latch
- Transmitter disable input and receiver loss of signal output
- Wide operating temperature range –40°C ~85°C
- Single 3.3V power supply
- AC coupled LVPECL compatible data input and output
- 2-wire serial EEPROM protocol



Specifications

Parameter	Symbol	Min.	Тур.	Max.	Unit
Transmitter					
Data Rate (NRZ)	В	_	1250	-	Mb/s
Optical Output Power (avg.) (1) (2) (3)					
-1	Po	-11	-	-6	dBm
-2	Po	-5	-	-3	dBm
-3	Po	-1	-	-	dBm
Extinction Ratio (2)	ER	9	-	-	dB
Optical Wavelength					
1310nm FP LD ⁽²⁾	λ_{C}	1270	1310	1355	nm
1550nm DFB LD	λ_{C}	1530	1550	1570	nm
Spectral Width					
1310nm FP LD (RMS) ⁽²⁾	Δλ	-	-	2.5	nm
1550nm DFB LD (-20dB)	Δλ	-	-	1	nm
Side Mode Suppression Ratio					
1550nm DFB LD	SMSR	30	-	-	dB
Output Rise Time (20-80%) (2)	t _r	_	-	260	ps
Output Fall Time (20-80%) (2)	t _f	_	-	260	ps
Data Differential Input Voltage	Vi	500	-	2400	mV_{p-p}
TX Fault Output Voltage	V _{FOL} V _{FOH}	0 2.4		0.4 Vcc	V



Parameter	Symbol	Min.	Тур.	Max.	Unit
TX Disable Input Voltage	V_{DIL}	0	-	0.8	V
·	V _{DIH}	2	-	Vcc	.,
Supply Voltage	Vcc	2.97	3.3	3.63	V
Supply Current	Icc	ı	-	150	mA
Receiver					
Data Rate (NRZ)	В	-	1250	-	Mb/s
Optical Input Sensitivity (avg.) (1) (2) (5)					
-1	P _{IN}	-	-	-20	dBm
-2	P _{IN}	_	-	-23	dBm
Saturation (avg. power)	P _{SAT}	-3	-	-	dBm
Optical Wavelength	λ	1100	-	1600	nm
Output Rise Time (20-80%)	t _r	-	-	250	ps
Output Fall Time (20-80%)	t _f	-	-	250	ps
Data Differential Output Voltage	Vo	370	-	2000	mV _{p-p}
LOS Deasserted Power Level (avg.)	P_A	-	-	-20	dBm
LOS Asserted Power Level (avg.)	P_{D}	-36	-	-	dBm
LOS Hysteresis	P _{HYS}	0.5	3	-	dB
LOS Output Voltage	V _{LOS-OL}	0	-	0.4	V
Loo Output Voltage	V_{LOS-OH}	2.4	-	Vcc	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Supply Voltage	Vcc	2.97	3.3	3.63	V
Supply Current	Icc	-	-	130	mA

Notes:

- (1) With 0.275 NA, $9/125\mu m$ fiber.
- (2) Compliant to IEEE802.3z Gigabit Ethernet 1000BASE-LX.
- (3) Class 1 eye safe per FDA and IEC.
- (4) Transmitter eye mask diagram is compliant to IEEE802.3z Eye Diagram.
 (5) 2⁷ -1 PRBS, BER= 10⁻¹².
- (6) The transmitter output should not be viewed directly.

Absolute Maximum Ratings

Parameter		Min.	Max.	Unit
Operating Temperature	-1	0	70	°C
Operating remperature	-2	-40	85	°C
Storage Temperature		-40	100	°C
Lead Soldering Limits		-	240/10	°C /sec
Supply Voltage		-0.5	4	V

Digital Diagnostic Monitor Characteristics

Parameter	Min.	Unit
Transceiver Internal Temperature Accuracy	±3.0	°C
Transceiver Internal Supply Voltage Accuracy	±3	%
TX Laser Bias Current Accuracy	±1 0	%
TX Average Output Power Accuracy	±3.0	dB
RX Average Input Power Accuracy	±3.0	dB



Timing of Control and Status I/O

D	0	N4"		1114	O 1242
Parameter	Symbol	Min.	Max.	Unit	Condition
TX Disable Assert	t off		10	μs	Time from rising edge of TX Disable to when the
Time	1_011		10	μ 3	optical output falls below 10% of nominal.
TX Disable Negate					Time from falling edge of TX Disable to when the
TX Disable Negate	t_on		1	ms	modulated optical output rises above 90% of
Time					nominal.
Time to initialize,					From power on or negation of TX Fault using TX
including reset of	t_init		300	ms	Disable.
TX_Fault					
TX Fault Assert Time	t_fault		100	μ s	Time from fault to TX fault on.
TV Disable to react	t rooot	10			Time TX Disable must be held high to reset
TX Disable to reset	t_reset	10		μ S	TX_fault.
LOS Assert Time	t_loss_on		100	μ s	Time from LOS state to RX LOS assert.
LOS Deassert Time	t_loss_off		100	μs	Time from non-LOS state to RX LOS deassert.
Serial ID Clock Rate	f_serial_clock		100	kHz	

Ordering Information

T R 🗌 🗆 R 🖂 🖂 - 3 [
	Operating Temperature Range: 1:0°C ~ 70°C 2:-40°C ~ 85°C Sensitivity Grade: 1:-1 2:-2 3:-3
	Tx Output Power Grade: 1:-1 2:-2 3:-3

15: 1550nm FP LD 55: 1550nm DFB LD



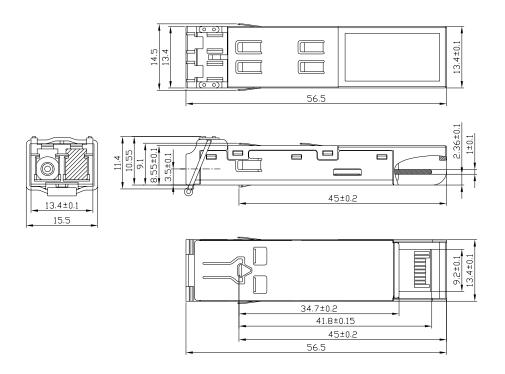
Part Number	Laser Type	Power Budget	Recommended Maximum Reach (2)	Compliant to Gigabit Ethernet ⁽⁴⁾
TR13R55-311RLC3MF D TR55R13-311RLC3MF D	1310nm, FP 1550nm, DFB	9dB	20Km	1000BASE-LX
TR13R55-321RLC3MF□D TR55R13-321RLC3MF□D	1310nm, FP 1550nm, DFB	15dB	40Km	1
TR13R55-332RLC3MF D TR55R13-332RLC3MF D	1310nm, FP 1550nm, DFB	22dB	70Km	-

Notes:

- (1) Power Budget (min.) = TX Output Power (min.) RX Sensitivity (max.)
- (2) Assuming connector loss 2dB; 1310nm fiber attenuation coefficient 0.3dB/Km; 1550nm fiber attenuation coefficient 0.25dB/Km.
- (3) The maximum reach value is recommended, not guaranteed. The exact transmission distance depends on fiber loss, connector loss and system penalty.
- (4) Gigabit Ethernet standard specification is defined in IEEE802.3z.

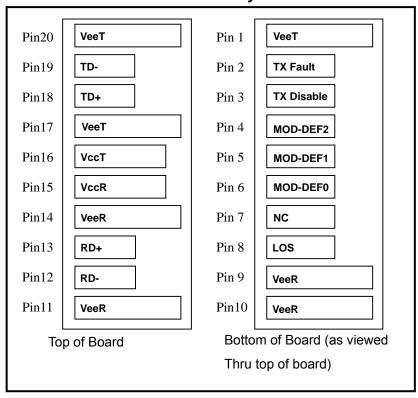


Outline Drawing



UNIT: mm

SFP Transceiver Electrical Pad Layout





Pin Description

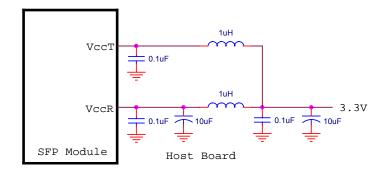
Pin No.	Symbol	Description
1	VeeT	Transmitter Ground
		Transmitter Fault Indication
		Logic Low indicates normal operation.
2	TX Fault	Logic High Indicates a laser fault of some kind.
		TX Fault is an open drain output, which should be pulled up with a $4.7K - 10K\Omega$
		resistor on the host board.
		Transmitter Disable
		Its states are :
		Low (0 – 0.8V) : Transmitter on
3	TX Disable	(>0.8, < 2.0V) : Undefined
	17. 2.000.0	High (2.0 – 3.465V) : Transmitter Disabled
		Open : Transmitter Disabled
		It is pulled up within the module with a $4.7K - 10 K.\Omega$ resistor.
		Module Definition 2 (SDA)
		The data line of two wire serial interface for serial ID.
4	MOD-DEF2	MOD-DEF2 should be pulled up with a $4.7K - 10K\Omega$ resistor on the host board.
		The pull-up voltage shall be VccT or VccR.
		Module Definition 1 (SCL)
		The clock line of two wire serial interface for serial ID.
5	MOD-DEF1	MOD-DEF1 should be pulled up with a $4.7K - 10K\Omega$ resistor on the host board.
		The pull-up voltage shall be VccT or VccR.
_		Module Definition 0 (WP)
6	MOD-DEF0	MOD-DEF0 is grounded by the module to indicate that the module is present.
7	NC	Not connected
		Loss of Signal
		Logic High indicates the received optical power is below the worst-case receiver
	1.00	sensitivity.
8	LOS	Logic Low indicates normal operation.
		LOS is an open drain output, which should be pulled up with a 4.7K – 10 K Ω
		resistor on the host board.
9	VeeR	Receiver Ground
10	VeeR	Receiver Ground
11	VeeR	Receiver Ground
12	RD-	Inv. Received Data Out (Note 1)
13	RD+	Received Data Out (Note 1)
14	VeeR	Receiver Ground
15	VccR	Receiver Power Supply
16	VccT	Transmitter Power Supply
17	VeeT	Transmitter Ground
18	TD+	Transmitter Data In (Note 2)
19	TD-	Inv. Transmit Data In (Note 2)
20	VeeT	Transmitter Ground

Notes:

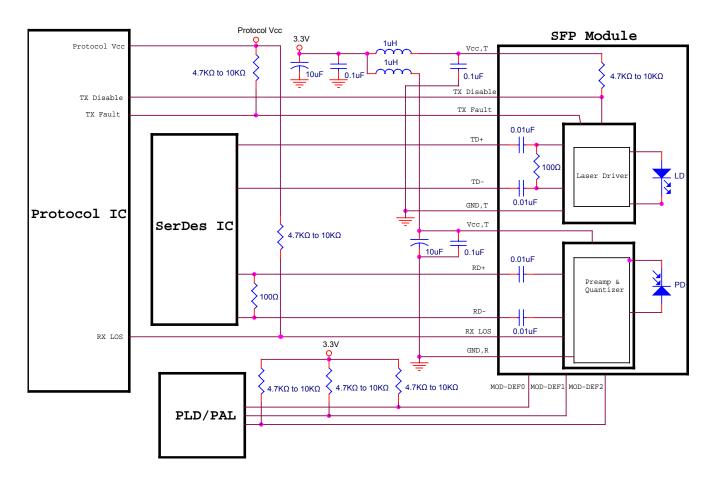
- 1. RD+ and RD- are AC coupled $100\,\Omega$ differential lines which should be terminated with $100\,\Omega$ (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 370 and 2000 mV differential (185 1000 mV single ended) when properly terminated.
- 2. TD+ and TD- are AC-coupled, differential lines with $100\,\Omega$ differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 500-2400 mV (250-1200 mV single-ended), though it is recommended that values between 500 and 1200 mV differential (250-600 mV single-ended) be used for best EMI performance.



Recommended Host Board Supply Filtering Network

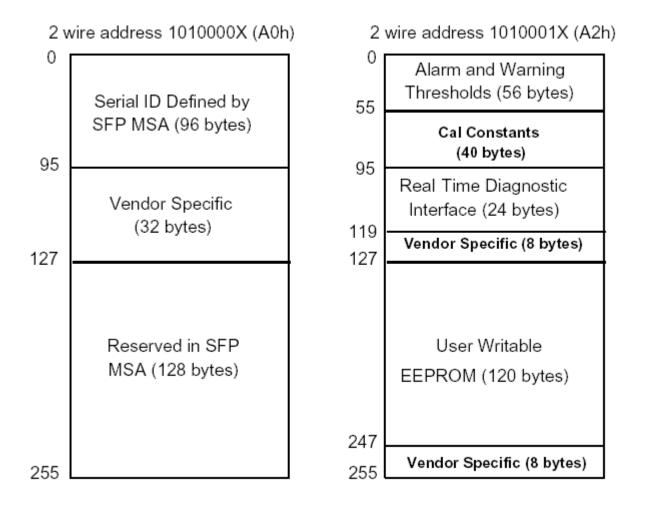


Example SFP Host Board Schematic





Memory Map





EEPROM Serial ID Memory Contents (A0h)

Address	Hex	ASCII	Address	Hex	ASCII	Address	Hex	ASCII	Address	Hex	ASCII
0	03		32	20		64	00		96	20	
1	04		33	20		65	1A		97	20	
2	07		34	20		66	00		98	20	
3	00		35	20		67	00		99	20	
4	Note1		36	00		68			100	20	
5	Note1		37	20		69			101	20	
6	00		38	20		70			102	20	
7	00		39	20		71			103	20	
8	00		40	54	Τ	72			104	20	
9	00		41	52	R	73			105	20	
10	00		42	Note1	*	74			106	20	
11	05		43	Note1	*	75	Notes		107	20	
12	02		44	53	S	76	Note3		108	20	
13	00		45	4D	М	77			109	20	
14	Note1		46	33	3	78			110	20	
15	Note1		47	2D	ı	79			111	20	
16	Note1		48	Note1	*	80			112	20	
17	Note1		49	Note1	*	81			113	20	
18	00		50	4C	L	82			114	20	
19	00		51	43	С	83			115	20	
20	41	Α	52	33	3	84			116	20	
21	50	Р	53	4D	М	85			117	20	
22	50	Р	54	52	R	86			118	20	
23	4F	0	55	Note1	*	87	Note4		119	20	
24	49		56	46	F	88	NOIE4		120	20	
25	4E	N	57	20		89			121	20	
26	54	Τ	58	20		90			122	20	
27	45	E	59	20		91			123	20	
28	43	С	60	Note1		92	68		124	20	
29	48	Н	61	Note1		93	B0		125	20	
30	20		62	00		94	01		126	20	
31	20		63	Note2		95	Note2		127	20	

Notes:

- 1. Data will vary depends on product.
- 2. Addresses 63 is check sum of bytes 0 62. Addresses 95 is check sum of bytes 64 94.
- 3. These addresses are reserved for serial number information.
- 4. These addresses are reserved for date code information.
- 5. The data transfer protocol and complete description of A0h memory contents are defined in SFP MSA and SFF-8472.



Digital Diagnostic

Alarm and Warning Thresholds (2-Wire Address A2h)

Address	#Bytes	Name	Description	Value
00-01	2	Temp High Alarm	MBS at low address	100°C
02-03	2	Temp Low Alarm	MBS at low address	-40°C
04-05	2	Temp High Warning	MBS at low address	+85°C
06-07	2	Temp Low Warning	MBS at low address	-35°C
08-09	2	Voltage High Alarm	MBS at low address	3.9V
10-11	2	Voltage Low Alarm	MBS at low address	2.7V
12-13	2	Voltage High Warning	MBS at low address	3.63V
14-15	2	Voltage Low Warning	MBS at low address	2.97V
16-17	2	Bias High Alarm	MBS at low address	70mA
18-19	2	Bias Low Alarm	MBS at low address	4mA
20-21	2	Bias High Warning	MBS at low address	60mA
22-23	2	Bias Low Warning	MBS at low address	5mA
24-25	2	TX Power High Alarm	MBS at low address	Note
26-27	2	TX Power Low Alarm	MBS at low address	Note
28-29	2	TX Power High Warning	MBS at low address	Note
30-31	2	TX Power LOW Warning	MBS at low address	Note
32-33	2	RX Power High Alarm	MBS at low address	Note
34-35	2	RX Power Low Alarm	MBS at low address	Note
36-37	2	RX Power High Warning	MBS at low address	Note
38-39	2	RX Power Low Warning	MBS at low address	Note
40-55	16	Reserved	Reserved for future monitored quantities.	

Note: Data value will vary depends on product.



Calibration constants for External Calibration Option (2-Wire Address A2h)

Address	#Bytes	Name	Description	Value (Note)
56-59	4	Rx_PWR(4)	Single precision floating point calibration data - Rx optical power.	0
60-63	4	Rx_PWR(3)	Single precision floating point calibration data - Rx optical power.	0
64-67	4	Rx_PWR(2)	Single precision floating point calibration data, Rx optical power.	0
68-71	4	Rx_PWR(1)	Single precision floating point calibration data, Rx optical power.	1
72-75	4	Rx_PWR(0)	Single precision floating point calibration data, Rx optical power.	0
76-77	2	Tx_I(Slope)	Fixed decimal (unsigned) calibration data, laser bias current.	1
78-79	2	Tx_I(Offset)	Fixed decimal (signed two's complement) calibration data, laser bias current.	0
80-81	2	Tx_PWR(Slope)	Fixed decimal (unsigned) calibration data, transmitter coupled output power.	1
82-83	2	Tx_PWR(Offset)	Fixed decimal (signed two's complement) calibration data, transmitter coupled output power.	0
84-85	2	T (Slope)	Fixed decimal (unsigned) calibration data, internal module temperature.	1
86-87	2	T (Offset)	Fixed decimal (signed two's complement) calibration data, internal module temperature.	0
88-89	2	V (Slope)	Fixed decimal (unsigned) calibration data, internal module supply voltage.	1
90-91	2	V (Offset)	Fixed decimal (signed two's complement) calibration data, internal module supply voltage.	
92-94	3	Reserved	Reserved	
95	1	Checksum	Byte 95 contains the low order 8 bits of the sum of bytes 0 – 94.	

Notes: The device is internally calibrated.



A/D Values and Status Bits (2-Wire Address A2h)

Byte	Bit	Name	Description				
Converted analog values. Calibrated 16 bit data.							
96	All	Temperature MSB	Internally measured module temperature.				
97	All	Temperature LSB					
98	All	Vcc MSB	Internally measured supply voltage in transceiver.				
99	All	Vcc LSB					
100	All	TX Bias MSB	Internally measured TX Bias Current				
101	All	TX Bias LSB					
102	All	TX Power MSB	Measured TX output power.				
103	All	TX Power LSB					
104	All	RX Power MSB	Measured RX input power.				
105	All	RX Power LSB					
106	All	Reserved MSB	Reserved for 1 st future definition of digitized analog input				
107	All	Reserved LSB	Reserved for 1 st future definition of digitized analog input				
108	All	Reserved MSB	Reserved for 2 nd future definition of digitized analog input Reserved for 2 nd future definition of				
109	All	Reserved LSB	Reserved for 2 nd future definition of digitized analog input				
Option	al Stat	tus/Control Bits					
110	7	Tx Disable State	Digital state of the TX Disable Input Pin.				
110	6	Soft Tx Disable	Read/write bit that allows software disable of laser. It is not implemented, the transceiver ignores the value of this bit.				
110	5	Reserved	Reserved				
110	4	RX Rate Select State	Digital state of the SFP RX Rate Select Input Pin.				
110	3	Soft RX Rate Select	Read/write bit that allows software RX rate select. It is not implemented.				
110	2	TX Fault	Digital state of the TX Fault Output Pin.				
110	1	LOS	Digital state of the LOS Output Pin.				
110	0	Data_Ready_Bar	Indicates transceiver has achieved power up and data is ready.				
111	7-0	Reserved	Reserved				



Alarm and Warning Flag Bits (2-Wire Address A2h)

Byte	Bit	Name	Description
Reser	ved Op	tional Alarm and Warning	Flag Bits
112	7	Temp High Alarm	Set when internal temperature exceeds high alarm level.
112	6	Temp Low Alarm	Set when internal temperature is below low alarm level.
112	5	Vcc High Alarm	Set when internal supply voltage exceeds high alarm level.
112	4	Vcc Low Alarm	Set when internal supply voltage is below low alarm level.
112	3	TX Bias High Alarm	Set when TX Bias current exceeds high alarm level.
112	2	TX Bias Low Alarm	Set when TX Bias current is below low alarm level.
112	1	TX Power High Alarm	Set when TX output power exceeds high alarm level.
112	0	TX Power Low Alarm	Set when TX output power is below low alarm level.
113	7	RX Power High Alarm	Set when Received Power exceeds high alarm level.
113	6	RX Power Low Alarm	Set when Received Power is below low alarm level.
113	5	Reserved Alarm	
113	4	Reserved Alarm	
113	3	Reserved Alarm	
113	2	Reserved Alarm	
113	1	Reserved Alarm	
113	0	Reserved Alarm	
114	All	Reserved	
115	All	Reserved	
116	7	Temp High Warning	Set when internal temperature exceeds high warning level.
116	6	Temp Low Warning	Set when internal temperature is below low warning level.
116	5	Vcc High Warning	Set when internal supply voltage exceeds high warning level.
116	4	Vcc Low Warning	Set when internal supply voltage is below low warning level.
116	3	TX Bias High Warning	Set when TX Bias current exceeds high warning level.
116	2	TX Bias Low Warning	Set when TX Bias current is below low warning level.
116	1	TX Power High Warning	Set when TX output power exceeds high warning level.
116	0	TX Power Low Warning	Set when TX output power is below low warning level.
117	7	RX Power High Warning	Set when Received Power exceeds high warning level.
117	6	RX Power Low Warning	Set when Received Power is below low warning level.
117	5	Reserved Warning	
117	4	Reserved Warning	
117	3	Reserved Warning	
117	2	Reserved Warning	
117	1	Reserved Warning	
117	0	Reserved Warning	
118	All	Reserved	



Vendor Specific Memory Addresses (2-Wire Address A2h)

Byte	Bit	Name	Description
120-127	All	Vendor Specific	Vendor Specific

User EEPROM (2-Wire Address A2h)

Address	#Bytes	Name	Description
128-247	120	User EEPROM	User writable EEPROM
248-255	8	Vendor Specific	Vendor specific control functions